

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Wood et al.

Serial No.: 10/799,258

Filed: March 12, 2004

For: METHOD FOR TESTING USING A
UNIVERSAL WAFER CARRIER FOR
WAFER LEVEL DIE BURN-IN (AS
AMENDED)

Confirmation No.: 8225

Examiner: E. Karlsen

Group Art Unit: 2829

Attorney Docket No.: 2269-2825.13US
(90-0051.15/US)

Notice of Allowance Mailed:

March 28, 2007

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July 27, 2007

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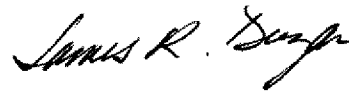
1. This letter is to specify that the FEE ADDRESSEE for this patent is:

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8000 South Federal Way
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2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



James R. Duzan
Registration No. 28,393
Attorney for Applicants
TRASKBRITT
P.O. Box 2550
Salt Lake City, Utah 84110-2550
Telephone: 801-532-1922

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